



AiP74AHC3G04/AHCT3G04 Triple Inverter

Product Specification

Specification Revision History:

Version	Date	Description
2024-12-A0	2024-12	New
2025-04-A1	2025-04	Modify the parameters



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1、General Description

The AiP74AHC3G04/AiP74AHCT3G04 provides three inverters.

Features:

- Supply voltage range:
AiP74AHC3G04: 2.0V to 5.5V
AiP74AHCT3G04: 4.5V to 5.5V
- Input levels:
AiP74AHC3G04: CMOS level
AiP74AHCT3G04: TTL level
- Temperature range: -40°C to +125°C
- Packaging information: TSSOP8/VSSOP8/XSON8



Ordering Information:

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
AiP74AHC3G04 TA8.TR	TSSOP8	AiPHB 3G04	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 3.0mm×3.0mm Pin spacing:0.65mm
AiP74AHCT3G04 TA8.TR	TSSOP8	AiPHP 3G04	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 3.0mm×3.0mm Pin spacing:0.65mm
AiP74AHC3G04 YA8.TR	VSSOP8	AiP HBXX	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 2.0mm×2.3mm Pin spacing:0.50mm
AiP74AHCT3G04 YA8.TR	VSSOP8	AiP HPXX	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: 2.0mm×2.3mm Pin spacing:0.50mm
AiP74AHC3G04 EC8.TR	XSON8	HB XX	5000 PCS/reel	25000 PCS/box	Dimensions of plastic enclosure: 1.0mm×1.95mm Pin spacing:0.5mm
AiP74AHCT3G04 EC8.TR	XSON8	HP XX	5000 PCS/reel	25000 PCS/box	Dimensions of plastic enclosure: 1.0mm×1.95mm Pin spacing:0.5mm
AiP74AHC3G04 EB8.TR	XSON8	HB XX	5000 PCS/reel	25000 PCS/box	Dimensions of plastic enclosure: 1.0mm×1.35mm Pin spacing:0.35mm
AiP74AHCT3G04 EB8.TR	XSON8	HP XX	5000 PCS/reel	25000 PCS/box	Dimensions of plastic enclosure: 1.0mm×1.35mm Pin spacing:0.35mm

Note 1: "XX" refers to variable content, meaning year and package batch serial number.

Note 2: If the physical information is inconsistent with the ordering information, please refer to the actual product.



2、Block Diagram And Pin Description

2.1、Block Diagram

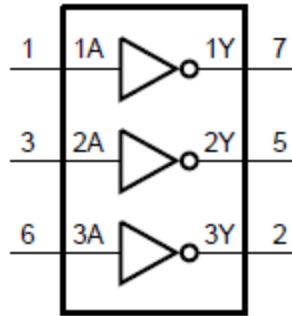
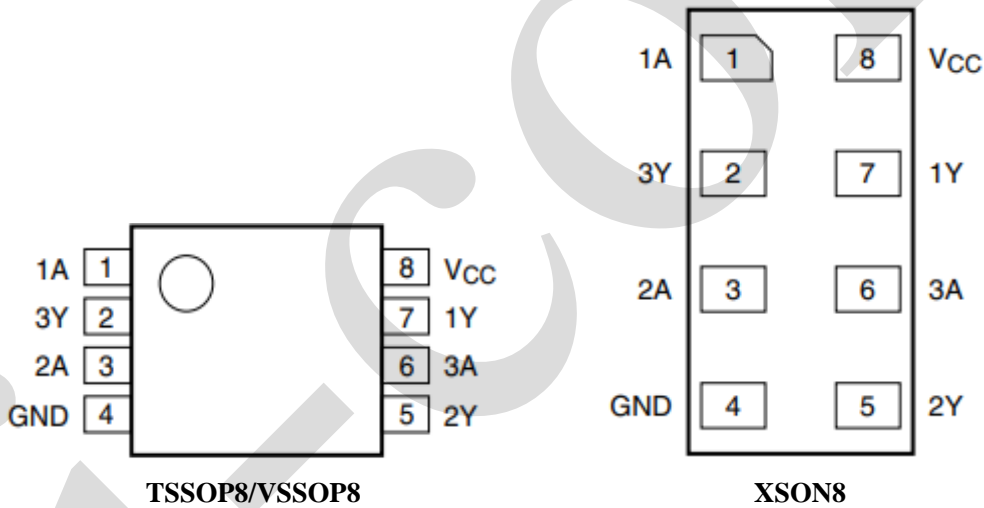


Figure 1. Logic symbol



Figure 2. Logic diagram (one gate)

2.2、Pin Configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	1A	data input
2	3Y	data output
3	2A	data input
4	GND	ground (0 V)
5	2Y	data output
6	3A	data input
7	1Y	data output
8	V _{CC}	supply voltage



2.4、Function Table

Input	Output
nA	nY
L	H
H	L

Note: H=HIGH voltage level; L=LOW voltage level.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+7	V
supply current	I_{CC}	-	-	50	mA
ground current	I_{GND}	-	-50	-	mA
input clamping current	I_{IK}	$V_I < -0.5V$	-	± 20	mA
output clamping current	I_{OK}	$V_O < -0.5V$ or $V_O > V_{CC}+0.5V$	-	± 20	mA
output current	I_O	$-0.5V < V_O < V_{CC}+0.5V$	-	± 25	mA
storage temperature	T_{stg}	-	-65	+150	$^{\circ}C$
soldering temperature	T_L	10s	260		$^{\circ}C$

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
AiP74AHC3G04						
supply voltage	V_{CC}	-	2.0	5.0	5.5	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
ambient temperature	T_{amb}	-	-40	+25	+125	$^{\circ}C$
AiP74AHCT3G04						
supply voltage	V_{CC}	-	4.5	5.0	5.5	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
ambient temperature	T_{amb}	-	-40	+25	+125	$^{\circ}C$



3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit
AiP74AHC3G04							
HIGH-level input voltage	V _{IH}	2.0V	-	1.5	-	-	V
		3.0V	-	2.1	-	-	V
		5.5V	-	3.85	-	-	V
LOW-level input voltage	V _{IL}	2.0V	-	-	-	0.5	V
		3.0V	-	-	-	0.9	V
		5.5V	-	-	-	1.65	V
HIGH-level output voltage	V _{OH}	2.0V	I _O =-50uA	1.9	2.0	-	V
		3.0V	I _O =-50uA	2.9	3.0	-	V
		4.5V	I _O =-50uA	4.4	4.5	-	V
		3.0V	I _O =-4.0mA	2.48	-	-	V
		4.5V	I _O =-8.0mA	3.8	-	-	V
LOW-level output voltage	V _{OL}	2.0V	I _O =50uA	-	0	0.1	V
		3.0V	I _O =50uA	-	0	0.1	V
		4.5V	I _O =50uA	-	0	0.1	V
		3.0V	I _O =4.0mA	-	-	0.44	V
		4.5V	I _O =8.0mA	-	-	0.44	V
input leakage current	I _I	0V to 5.5V	V _I =5.5V or GND	-	-	±1	uA
supply current	I _{CC}	5.5V	V _I =V _{CC} or GND; I _O =0A	-	-	10	uA
AiP74AHCT3G04							
HIGH-level input voltage	V _{IH}	4.5V to 5.5V	-	2.0	-	-	V
LOW-level input voltage	V _{IL}	4.5V to 5.5V	-	-	-	0.8	V
HIGH-level output voltage	V _{OH}	4.5V	I _O =-50uA	4.4	4.5	-	V
			I _O =-8.0mA	3.8	-	-	V
LOW-level output voltage	V _{OL}	4.5V	I _O =50uA	-	0	0.1	V
			I _O =8.0mA	-	-	0.44	V
input leakage current	I _I	0V to 5.5V	V _I =V _{CC} or GND	-	-	±1	uA
supply current	I _{CC}	5.5V	V _I =V _{CC} or GND; I _O =0A	-	-	10	uA
additional supply current	ΔI _{CC}	4.5V to 5.5V	One input at 3.4V; Other inputs at V _{CC} or GND; I _O =0A	-	-	1.35	mA



3.3.2、DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit
AiP74AHC3G04							
HIGH-level input voltage	V _{IH}	2.0V	-	1.5	-	-	V
		3.0V	-	2.1	-	-	V
		5.5V	-	3.85	-	-	V
LOW-level input voltage	V _{IL}	2.0V	-	-	-	0.5	V
		3.0V	-	-	-	0.9	V
		5.5V	-	-	-	1.65	V
HIGH-level output voltage	V _{OH}	2.0V	I _O =-50uA	1.9	-	-	V
		3.0V	I _O =-50uA	2.9	-	-	V
		4.5V	I _O =-50uA	4.4	-	-	V
		3.0V	I _O =-4.0mA	2.4	-	-	V
		4.5V	I _O =-8.0mA	3.7	-	-	V
LOW-level output voltage	V _{OL}	2.0V	I _O =50uA	-	-	0.1	V
		3.0V	I _O =50uA	-	-	0.1	V
		4.5V	I _O =50uA	-	-	0.1	V
		3.0V	I _O =4.0mA	-	-	0.55	V
		4.5V	I _O =8.0mA	-	-	0.55	V
input leakage current	I _I	0V to 5.5V	V _I =5.5V or GND	-	-	±2	uA
supply current	I _{CC}	5.5V	V _I =V _{CC} or GND; I _O =0A	-	-	40	uA
AiP74AHCT3G04							
HIGH-level input voltage	V _{IH}	4.5V to 5.5V	-	2.0	-	-	V
LOW-level input voltage	V _{IL}	4.5V to 5.5V	-	-	-	0.8	V
HIGH-level output voltage	V _{OH}	4.5V	I _O =-50uA	4.4	-	-	V
			I _O =-8.0mA	3.7	-	-	V
LOW-level output voltage	V _{OL}	4.5V	I _O =50uA	-	-	0.1	V
			I _O =8.0mA	-	-	0.55	V
input leakage current	I _I	0V to 5.5V	V _I =V _{CC} or GND	-	-	±2	uA
supply current	I _{CC}	5.5V	V _I =V _{CC} or GND; I _O =0A	-	-	40	uA
additional supply current	ΔI _{CC}	4.5V to 5.5V	One input at 3.4V; Other inputs at V _{CC} or GND; I _O =0A	-	-	1.35	mA



3.3.3、AC Characteristics 1

($T_{amb}=-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit	
AiP74AHC3G04								
nA to nY propagation delay	t _{PLH} , t _{PHL}	3.0V to 3.6V	C _L =15pF	see Figure 4	-	4.3	8.5	ns
			C _L =50pF		-	6.1	12.0	ns
		4.5V to 4.5V	C _L =15pF		-	3.1	6.5	ns
			C _L =50pF		-	4.5	8.5	ns
AiP74AHCT3G04								
nAn to nYn propagation delay	t _{PLH} , t _{PHL}	5.5V	C _L =15pF	see Figure 4	-	3.4	7.5	ns
			C _L =50pF		-	4.9	8.5	ns

3.3.4、AC Characteristics 2

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit	
AiP74AHC3G04								
nA to nY propagation delay	t _{PLH} , t _{PHL}	3.0V to 3.6V	C _L =15pF	see Figure 4	-	-	11.0	ns
			C _L =50pF		-	-	14.5	ns
		4.5V to 4.5V	C _L =15pF		-	-	7.0	ns
			C _L =50pF		-	-	9.5	ns
AiP74AHCT3G04								
nAn to nYn propagation delay	t _{PLH} , t _{PHL}	5.5V	C _L =15pF	see Figure 4	-	-	8.5	ns
			C _L =50pF		-	-	10.0	ns



4、Testing Circuit

4.1、AC Testing Circuit

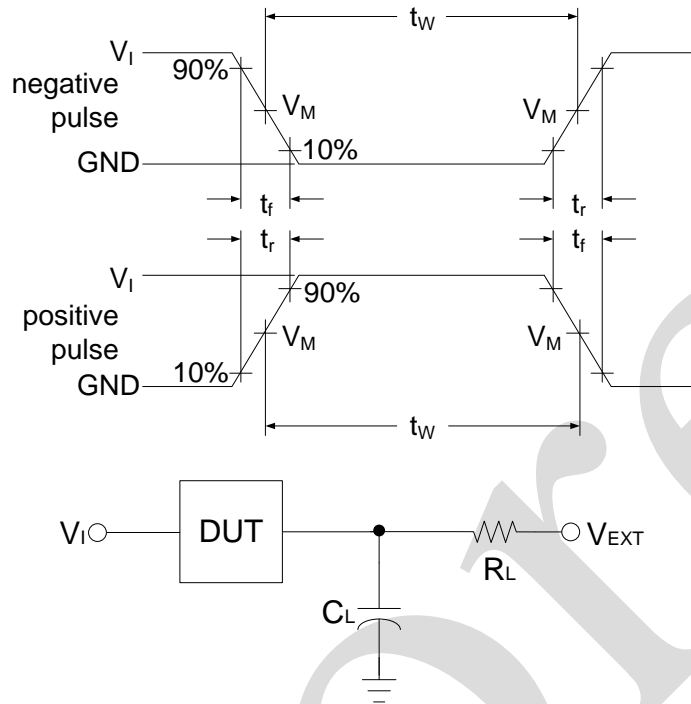


Figure 3. Test circuit for measuring switching times

C_L includes probe and jig capacitance.

4.2、Test Data

Type	Input		Load		V_{EXT}		
	V_I	$t_r = t_f$	C_L	R_L	t_{PLH}/t_{PHL}	t_{PLZ}/t_{PZL}	t_{PHZ}/t_{PZH}
AiP74AHC3G04	V_{CC}	3.0ns	15pF, 50pF	1k Ω	Open	V_{CC}	GND
AiP74AHCT3G04	3.0V	3.0ns	15pF, 50pF	1k Ω	Open	V_{CC}	GND



4.3、AC Testing Waveforms

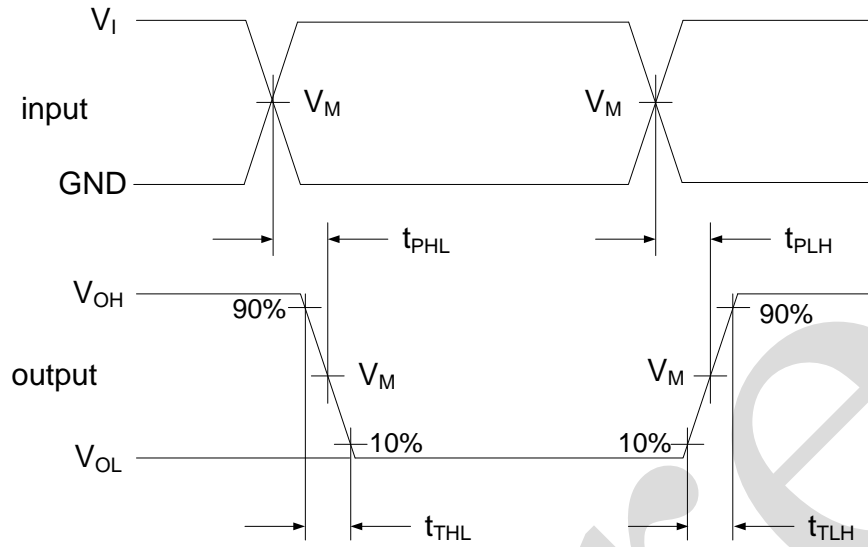


Figure 4. Propagation delay, output transition time

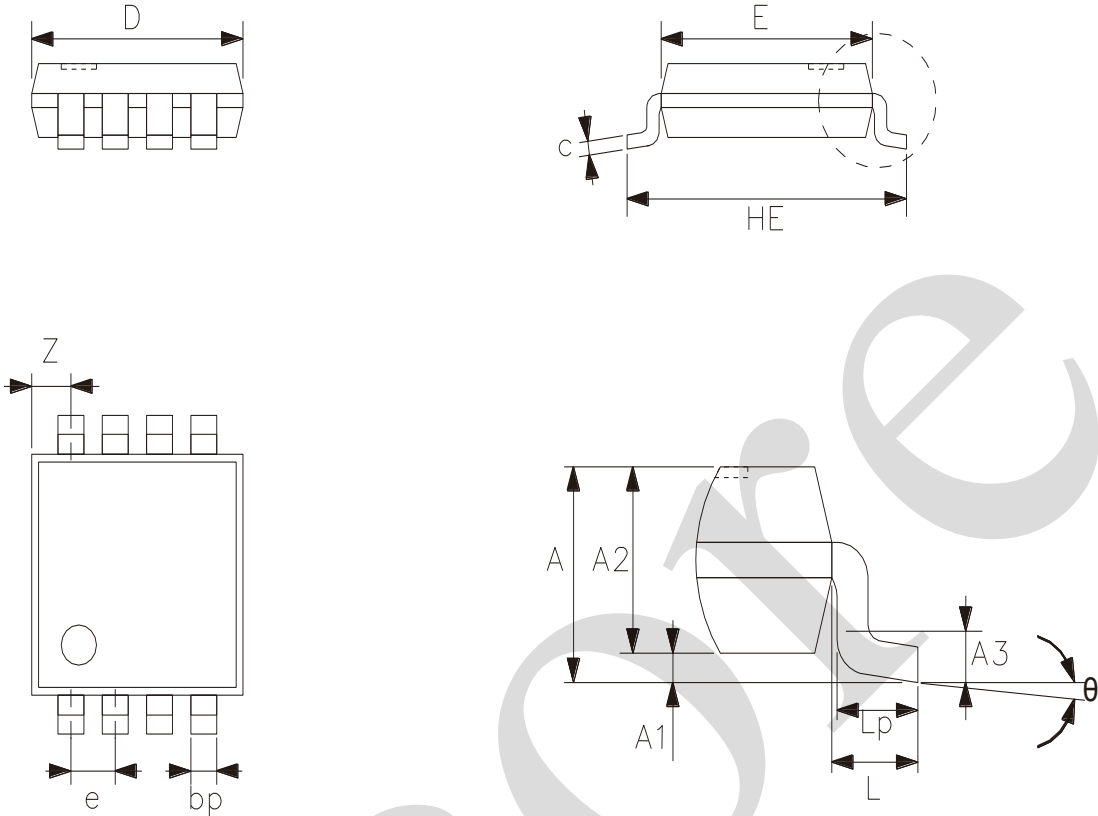
4.4、Measurement Points

Type	Input	Output
	V_M	V_M
AiP74AHC3G04	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
AiP74AHCT3G04	1.5V	$0.5 \times V_{CC}$



5、Package Information

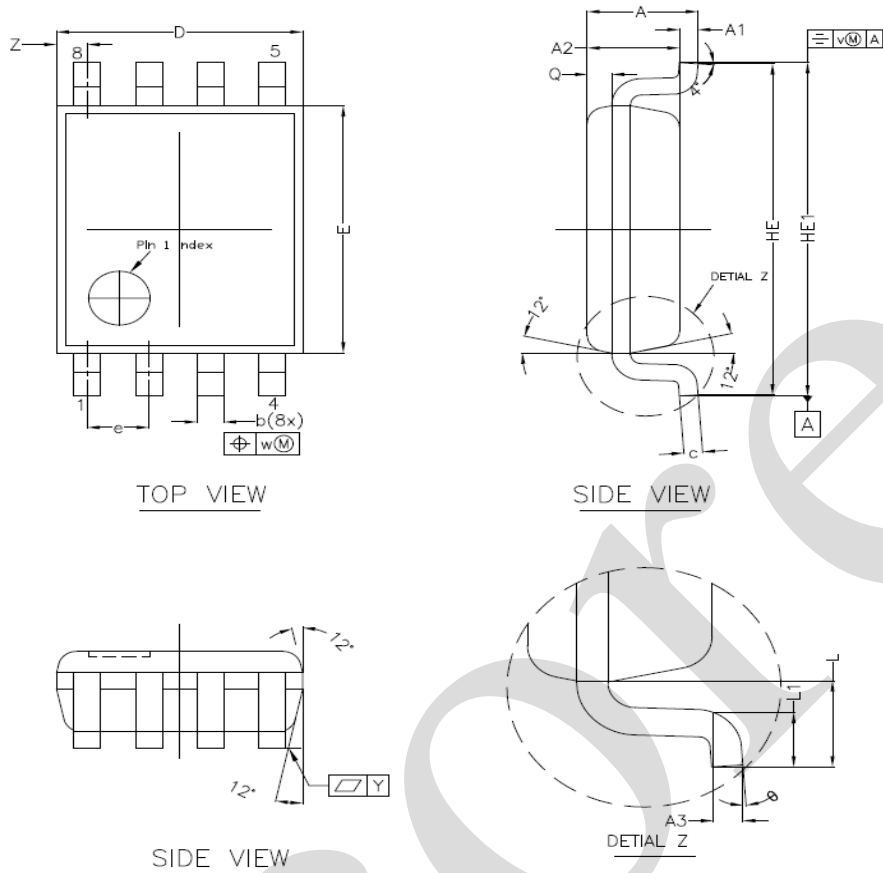
5.1、TSSOP8



2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	—	1.10
A1	0	0.15
A2	0.75	0.95
A3	0.25	
bp	0.22	0.38
c	0.08	0.18
D	2.90	3.10
E	2.90	3.10
HE	3.90	4.10
L	0.50	
Lp	0.33	0.47
e	0.65	
Z	0.35	0.70
θ	0°	8°



5.2、VSSOP8

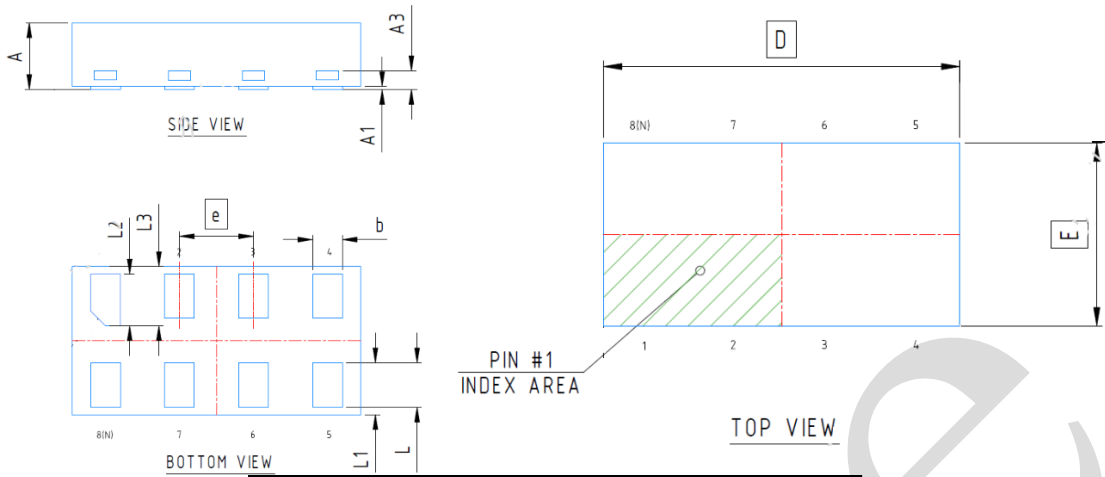


NOTES
 1.0 COP
 DIE ATTA
 2.0 D E

2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	—	1.00
A1	0.00	0.15
A2	0.60	0.85
A3	0.12	
Q	0.19	0.21
b	0.17	0.27
c	0.08	0.23
D	1.90	2.10
E	2.20	2.40
HE	3.00	3.20
HE1	3.00	3.40
e	0.50	
L	0.40	
L1	0.15	0.40
Y	0.10	
Z	0.10	0.40
θ	0°	8°



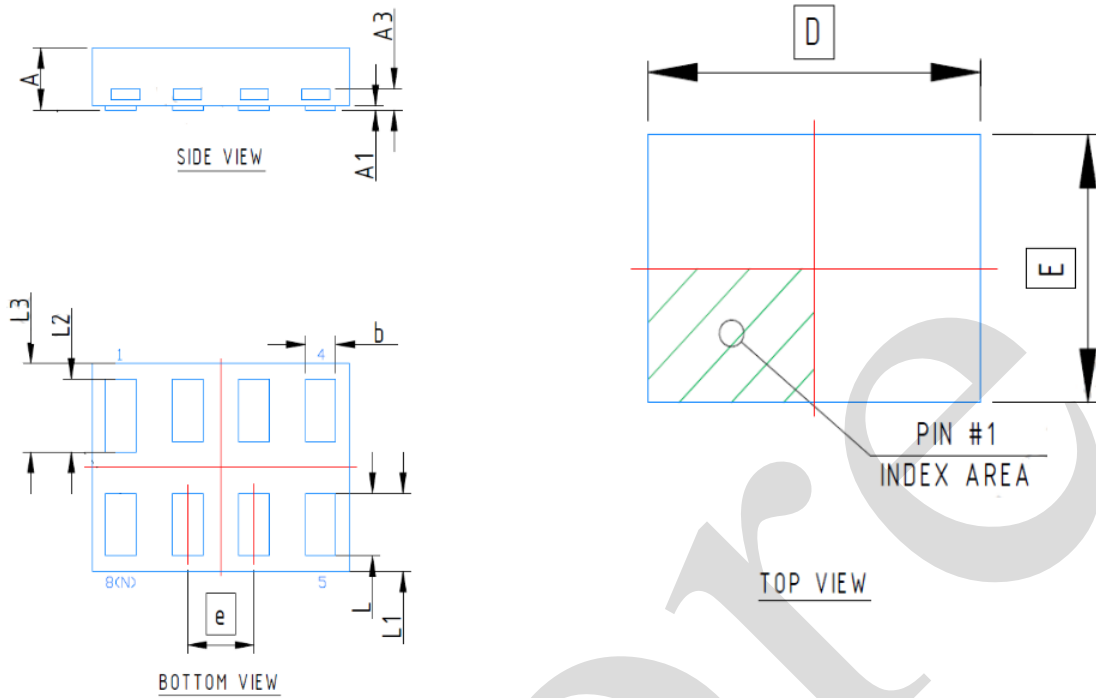
5.3、XSON8 (1*1.95)



2023/12/A	Dimensions In Millimeters	
	Symbol	Min
A	0.45	0.55
A1	0	0.05
A3	0.127	
b	0.15	0.25
D	1.95	
E	1.00	
e	0.50	
L	0.25	0.35
L1	0.25	0.45
L2	0.30	0.40
L3	0.30	0.50



5.4、XSON8 (1*1.35)



2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	0.28	0.32
A1	0.00	0.05
A3	0.10	
b	0.11	0.21
D	1.35	
E	1.00	
e	0.35	
L	0.25	0.35
L1	0.275	0.475
L2	0.30	0.40
L3	0.325	0.525



6、 Statements And Notes

6.1、 The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、 Notes

We recommend you to read this chapter carefully before using this product.

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